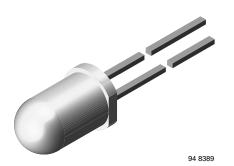
TSHG8400

www.vishay.com

Vishay Semiconductors

High Speed Infrared Emitting Diode, 830 nm, GaAlAs Double Hetero



TSHG8400 is an infrared, 830 nm emitting diode in GaAlAs

double hetero (DH) technology with high radiant power and

high speed, molded in a clear, untinted plastic package.

FEATURES

- Package type: leaded
- Package form: T-1¾
- Dimensions (in mm): Ø 5
- Peak wavelength: $\lambda_p = 830 \text{ nm}$
- High reliability
- · High radiant power
- High radiant intensity
- Angle of half intensity: $\varphi = \pm 22^{\circ}$
- Low forward voltage
- Suitable for high pulse current operation
- High modulation bandwidth: $f_c = 18$ MHz
- Good spectral matching with CMOS cameras
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Infrared radiation source for operation with CMOS cameras (illumination)
- High speed IR data transmission

PRODUCT SUMMARY COMPONENT Ie (mW/sr) φ (deg) λp (nm) tr (ns) TSHG8400 70 ± 22 830 20

Note

DESCRIPTION

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION							
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM				
TSHG8400	Bulk	MOQ: 4000 pcs, 4000 pcs/bulk	T-1¾				

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage		V _R	5	V			
Forward current		I _F	100	mA			
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA			
Surge forward current	t _p = 100 μs	I _{FSM}	1	А			
Power dissipation		Pv	180	mW			
Junction temperature		Тj	100	°C			
Operating temperature range		T _{amb}	- 40 to + 85	°C			
Storage temperature range		T _{stg}	- 40 to + 100	°C			
Soldering temperature	$t \le 5$ s, 2 mm from case	T _{sd}	260	°C			
Thermal resistance junction/ambient	J-STD-051, leads 7 mm soldered on PCB	R _{thJA}	230	K/W			

Document Number: 81297



COMPLIANT HALOGEN FREE <u>GREEN</u> (5-2008)

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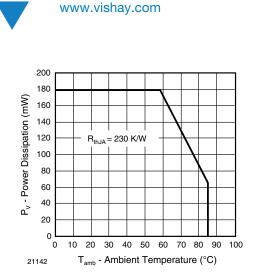


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

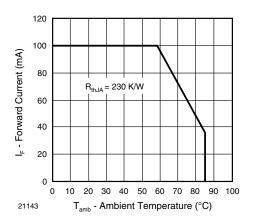


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V _F		1.5	1.8	V	
	I _F = 1 A, t _p = 100 μs	V _F		2.3		V	
Temperature coefficient of V_F	I _F = 1 mA	TK _{VF}		- 1.8		mV/K	
Reverse current	$V_R = 5 V$	I _R			10	μA	
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	Cj		125		pF	
Radiant intensity	I _F = 100 mA, t _p = 20 ms	l _e	45	70	135	mW/sr	
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	l _e		700		mW/sr	
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	\$e		50		mW	
Temperature coefficient of ϕ_{e}	I _F = 100 mA	TKφ _e		- 0.35		%/K	
Angle of half intensity		φ		± 22		deg	
Peak wavelength	I _F = 100 mA	λρ		830		nm	
Spectral bandwidth	I _F = 100 mA	Δλ		40		nm	
Temperature coefficient of λ_p	I _F = 100 mA	ΤΚλρ		0.25		nm/K	
Rise time	I _F = 100 mA	t _r		20		ns	
Fall time	I _F = 100 mA	t _f		13		ns	
Cut-off frequency	$I_{DC} = 70 \text{ mA}, I_{AC} = 30 \text{ mA pp}$	f _c		18		MHz	
Virtual source diameter		d		3.7		mm	

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

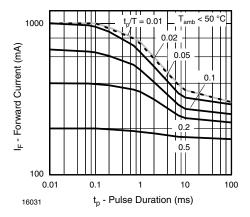


Fig. 3 - Pulse Forward Current vs. Pulse Duration

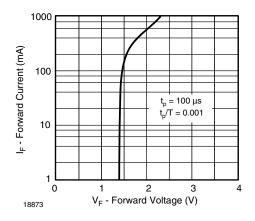


Fig. 4 - Forward Current vs. Forward Voltage

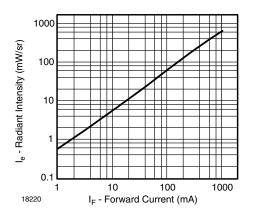


Fig. 5 - Radiant Intensity vs. Forward Current

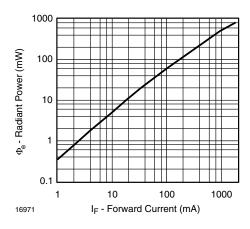


Fig. 6 - Radiant Power vs. Forward Current

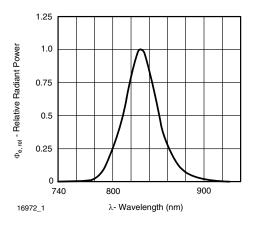


Fig. 7 - Relative Radiant Power vs. Wavelength

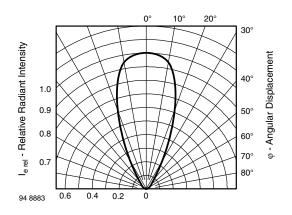


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

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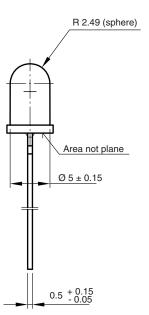


PACKAGE DIMENSIONS in millimeters

 7.7 ± 0.15

8.7 ± 0.3

 34.3 ± 0.55





technical drawings according to DIN specifications

Drawing-No.: 6.544-5259.06-4 Issue: 6; 19.05.09

0.5 + 0.15 - 0.05

2.54 nom.

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